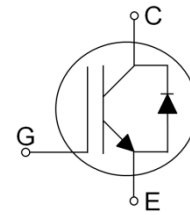


**Features:**

- 1200V NPT Trench Technology
- High Speed Switching
- Low Conduction Loss
- Positive Temperature Coefficient
- Easy parallel Operation
- RoHS compliant
- JEDEC Qualification



**Applications :**

Induction Heating, general purpose inverter application

Device	Package	Marking	Remark
GPA040A120L-ND	TO-264	GPA040A120L-ND	RoHS

**Absolute Maximum Ratings**

Parameter	Symbol	Value	Unit	
Collector-Emitter Voltage	$V_{CES}$	1200	V	
Gate-Emitter Voltage	$V_{GES}$	±20	V	
Continuous Collector Current	$I_c$	$T_C = 25\text{ °C}$	80	A
		$T_C = 100\text{ °C}$	40	A
Pulsed Collector Current (Note 1)	$I_{CM}$	120	A	
Diode Continuous Forward Current	$I_F$	40	A	
Diode Maximum Forward Current	$I_{FM}$	120	A	
Power Dissipation	$P_D$	$T_C = 25\text{ °C}$	455	W
		$T_C = 100\text{ °C}$	182	W
Operating Junction Temperature	$T_J$	-55 ~ 150	°C	
Storage Temperature Range	$T_{STG}$	-55 ~ 150	°C	
Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	$T_L$	300	°C	

Notes :

(1) Repetitive rating : Pulse width limited by maximum junction temperature

**Thermal Characteristics**

Parameter	Symbol	Value	Unit
Maximum Thermal resistance, Junction-to-Case	$R_{\theta JC}$ (IGBT)	0.275	°C/W
Maximum Thermal resistance, Junction-to-Case	$R_{\theta JC}$ (DIODE)	0.95	°C/W
Maximum Thermal resistance, Junction-to-Ambient	$R_{\theta JA}$	25	°C/W

**Electrical Characteristics of the IGBT  $T_C=25^\circ\text{C}$ , unless otherwise noted**

Parameter	Symbol	Test condition	Min.	Typ.	Max.	Unit
<b>OFF</b>						
Collector – Emitter Breakdown Voltage	$BV_{CES}$	$V_{GE} = 0V, I_C = 1mA$	1200	--	--	V
Zero Gate Voltage Collector Current	$I_{CES}$	$V_{CE} = 1200V, V_{GE} = 0V$	--	--	1	mA
Gate – Emitter Leakage Current	$I_{GES}$	$V_{CE} = 0V, V_{GE} = \pm 20V$	--	--	$\pm 250$	nA
<b>ON</b>						
Gate – Emitter Threshold Voltage	$V_{GE(TH)}$	$V_{GE} = V_{CE}, I_C = 40mA$	4.0	6.0	8.0	V
Collector – Emitter Saturation Voltage	$V_{CE(SAT)}$	$V_{GE} = 15V, I_C = 40A, T_C = 25^\circ\text{C}$	--	2.0	2.8	V
		$V_{GE} = 15V, I_C = 40A, T_C = 125^\circ\text{C}$	--	2.5	--	V
<b>DYNAMIC</b>						
Input Capacitance	$C_{IES}$	$V_{CE} = 30V,$ $V_{GE} = 0V$ $f = 1MHz$	--	5150	--	pF
Output Capacitance	$C_{OES}$		--	150	--	pF
Reverse Transfer Capacitance	$C_{RES}$		--	100	--	pF
<b>SWITCHING</b> (Note 2)						
Turn-On Delay Time	$t_{d(on)}$	$V_{CC} = 600V, I_C = 40A$ $R_G = 5\Omega, V_{GE} = 15V$ Inductive Load, $T_C = 25^\circ\text{C}$	--	41	--	ns
Rise Time	$t_r$		--	82	--	ns
Turn-Off Delay Time	$t_{d(off)}$		--	200	--	ns
Fall Time	$t_f$		--	85	170	ns
Turn-On Switching Loss	$E_{ON}$		--	5.8	8.7	mJ
Turn-Off Switching Loss	$E_{OFF}$		--	1.5	2.3	mJ
Total Switching Loss	$E_{TS}$		--	7.3	11	mJ
Turn-On Delay Time	$t_{d(on)}$	$V_{CC} = 600V, I_C = 40A$ $R_G = 5\Omega, V_{GE} = 15V$ Inductive Load, $T_C = 125^\circ\text{C}$	--	45	--	ns
Rise Time	$t_r$		--	76	--	ns
Turn-Off Delay Time	$t_{d(off)}$		--	212	--	ns
Fall Time	$t_f$		--	189	--	ns
Turn-On Switching Loss	$E_{ON}$		--	5.6	8.4	mJ
Turn-Off Switching Loss	$E_{OFF}$		--	3.3	5	mJ
Total Switching Loss	$E_{TS}$		--	8.9	13.4	mJ
Total Gate Charge	$Q_g$	$V_{CC} = 600V, I_C = 40A$ $V_{GE} = 15V$	--	340	510	nC
Gate-Emitter Charge	$Q_{ge}$		--	45	67	nC
Gate-Collector Charge	$Q_{gc}$		--	155	230	nC
Short Circuit Withstanding Time	$t_{SC}$	$V_{CC} = 600V, V_{GE} = 15V$	10	--	--	$\mu\text{s}$

Notes :

(2) Not subject to production test – verified by design/characterization

**Electrical Characteristics of the DIODE  $T_C=25^{\circ}\text{C}$ , unless otherwise noted**

Parameter	Symbol	Test condition	Min.	Typ.	Max.	Unit	
Diode Forward Voltage	$V_{FM}$	$I_F = 40\text{A}$	$T_C = 25^{\circ}\text{C}$	--	2.8	--	V
			$T_C = 125^{\circ}\text{C}$	--	2.9	--	
Reverse Recovery Time	$t_{rr}$	$I_F = 40\text{A},$ $di/dt = 200\text{A}/\mu\text{s}$	$T_C = 25^{\circ}\text{C}$	--	220	--	ns
			$T_C = 125^{\circ}\text{C}$	--	310	--	
Reverse Recovery Current	$I_{rr}$		$T_C = 25^{\circ}\text{C}$	--	24	--	A
			$T_C = 125^{\circ}\text{C}$	--	36	--	
Reverse Recovery Charge	$Q_{rr}$		$T_C = 25^{\circ}\text{C}$	--	2600	--	nC
			$T_C = 125^{\circ}\text{C}$	--	5580	--	

## IGBT Characteristics

Fig. 1 Output characteristics

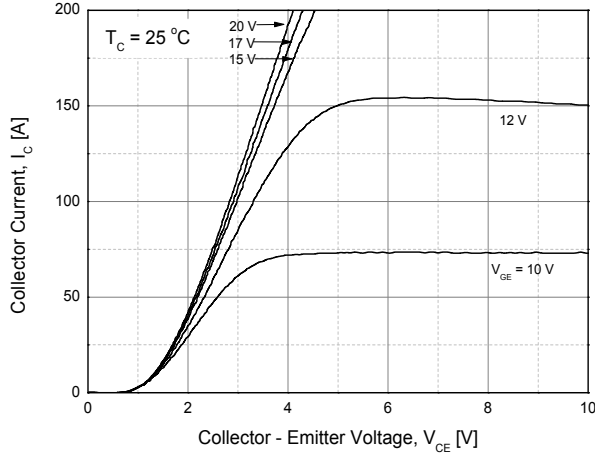


Fig. 2 Saturation voltage characteristics

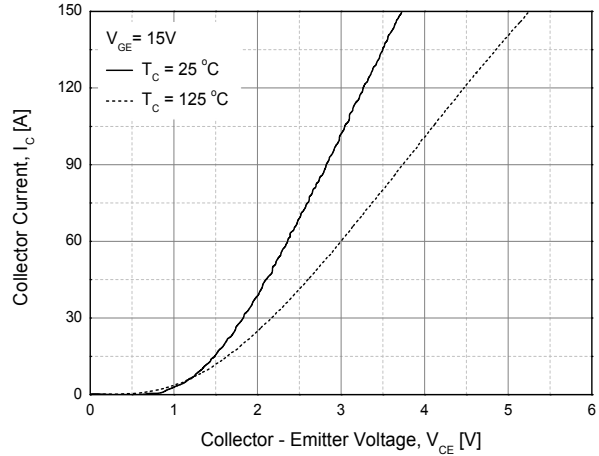


Fig. 3 Saturation voltage vs. collector current

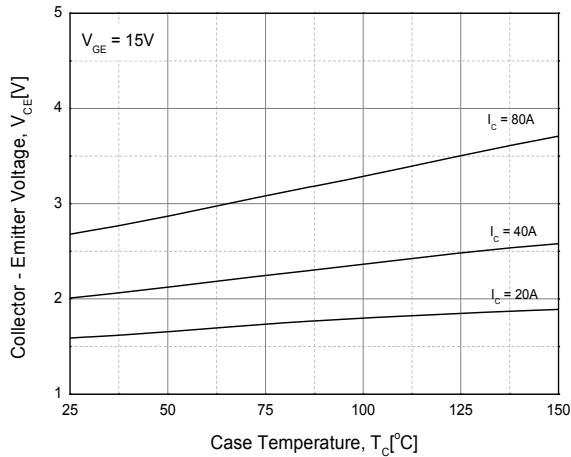


Fig. 4 Saturation voltage vs. gate bias

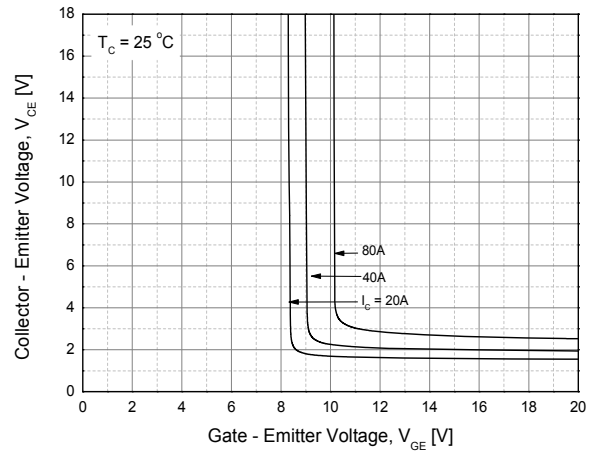


Fig. 5 Saturation voltage vs. gate bias

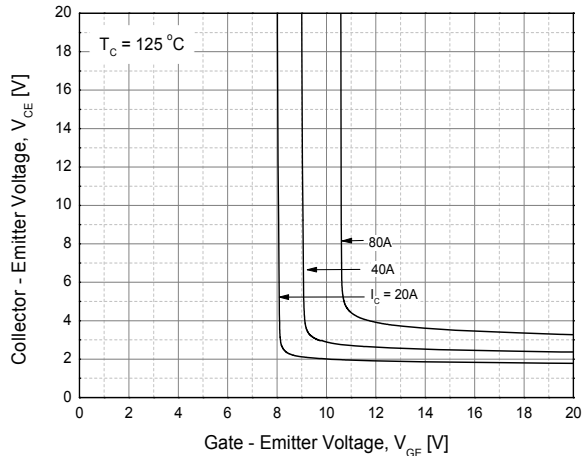
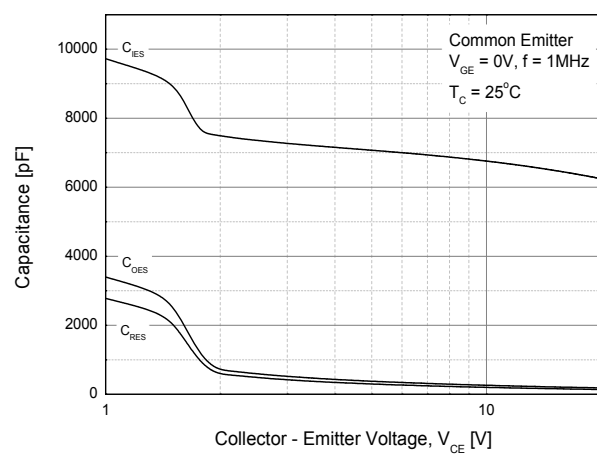


Fig. 6 Capacitance characteristics



## IGBT Characteristics

Fig. 7 Turn-on time vs. gate resistor

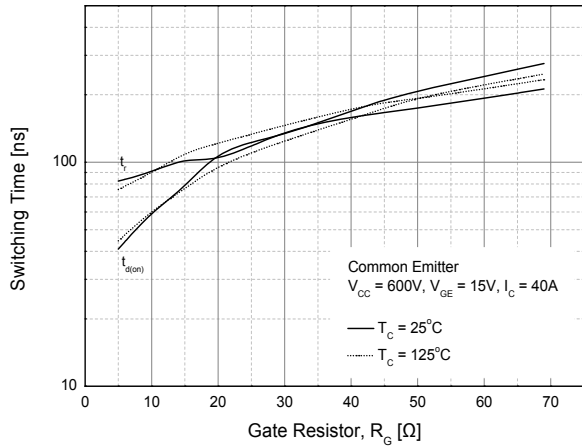


Fig. 8 Turn-off time vs. gate resistor

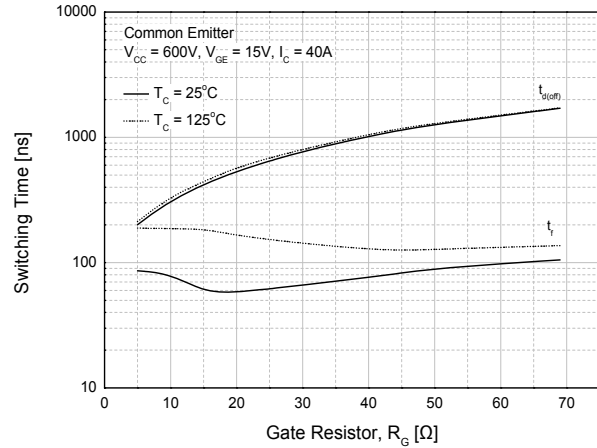


Fig. 9 Switching loss vs. gate resistor

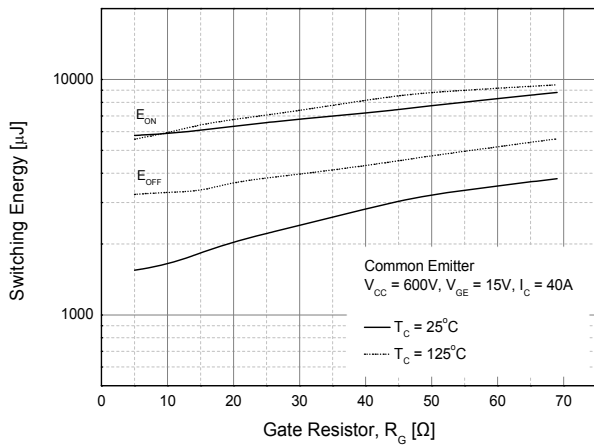


Fig. 10 Turn-on time vs. collector current

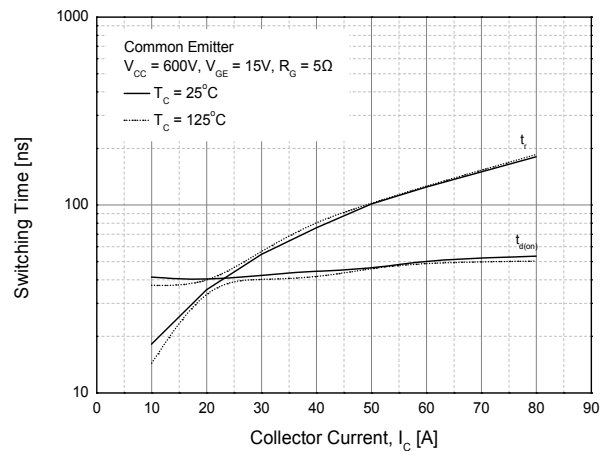


Fig. 11 Turn-off time vs. collector current

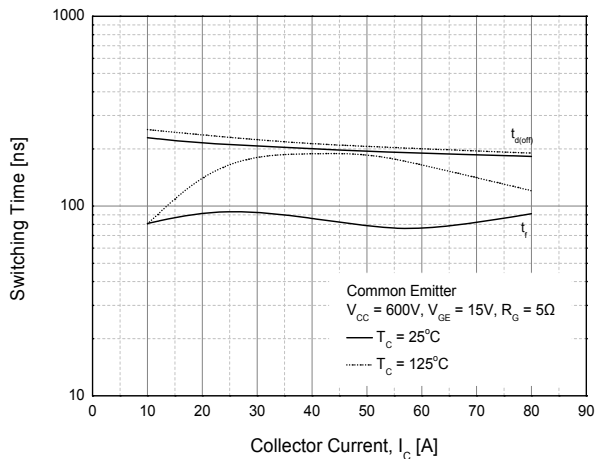
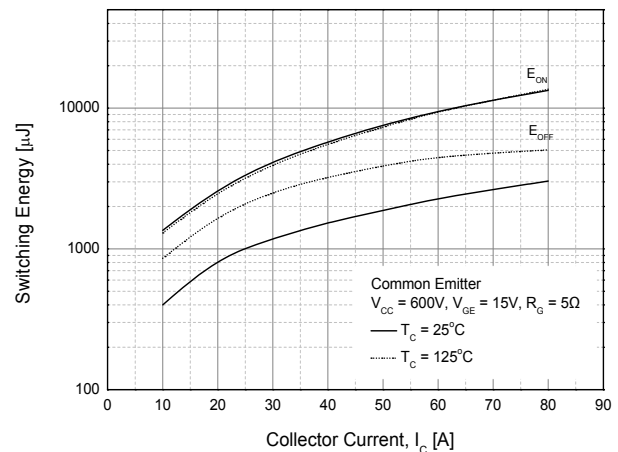


Fig. 12 Switching loss vs. collector current



## IGBT Characteristics

Fig. 13 Gate charge characteristics

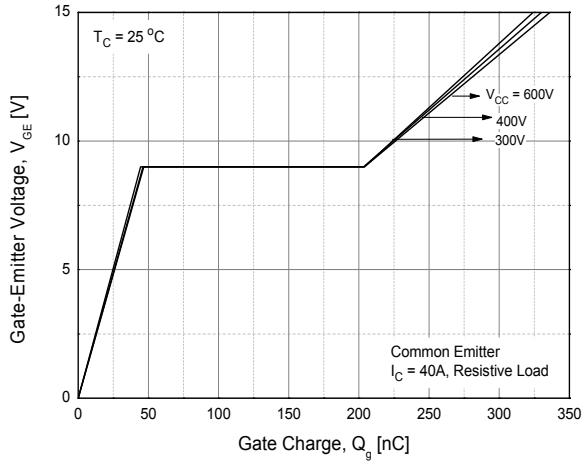


Fig. 14 SOA

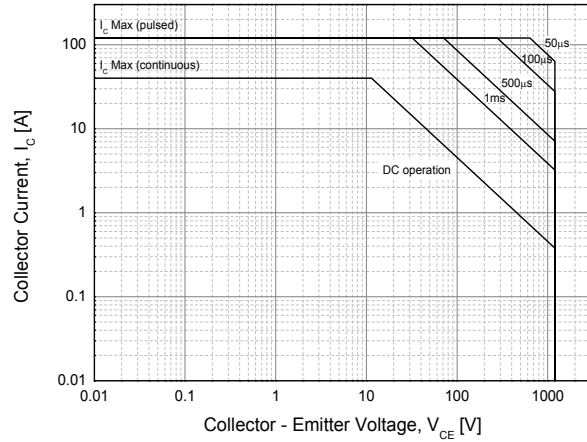


Fig. 15 RBSOA

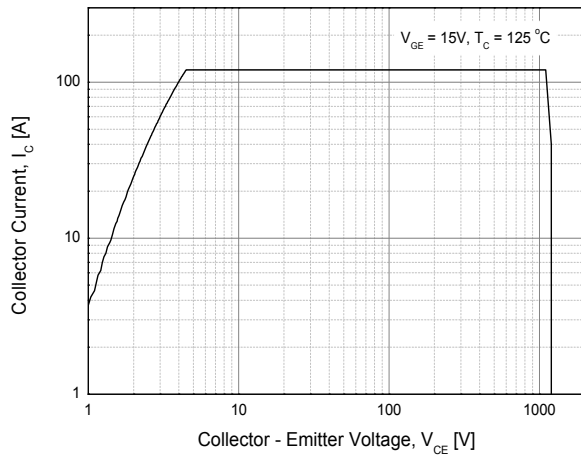


Fig. 16 Transient thermal impedance of IGBT

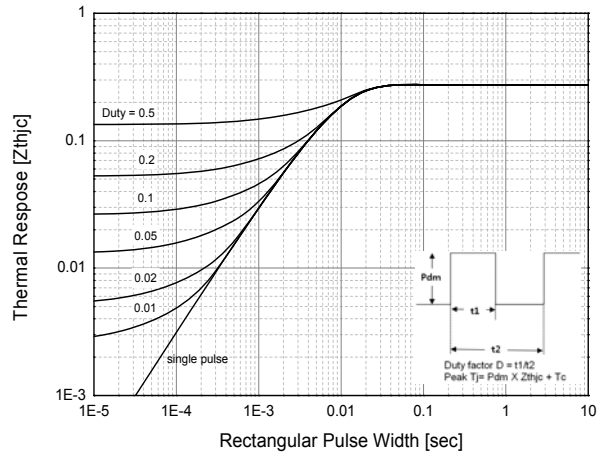
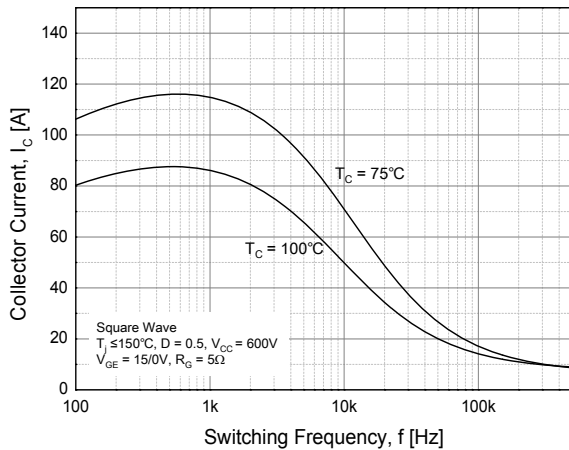


Fig. 17 Load Current vs. Frequency



## Diode Characteristics

Fig. 18 Conduction characteristics

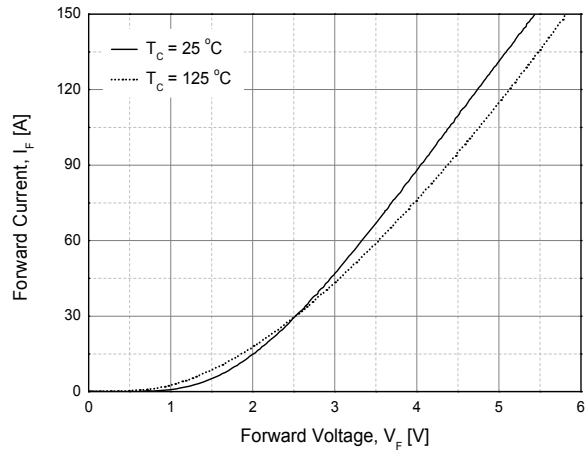


Fig. 19 Reverse recovery current vs. forward current

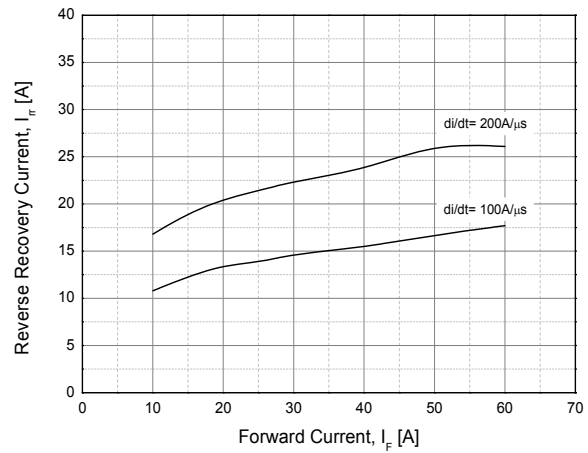


Fig. 20 Reverse recovery charge vs. forward current

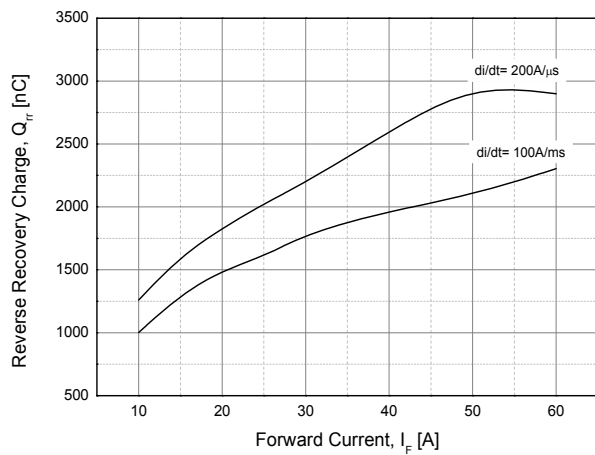
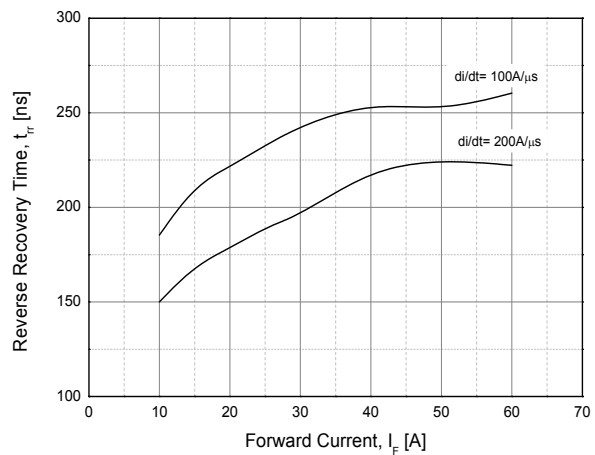
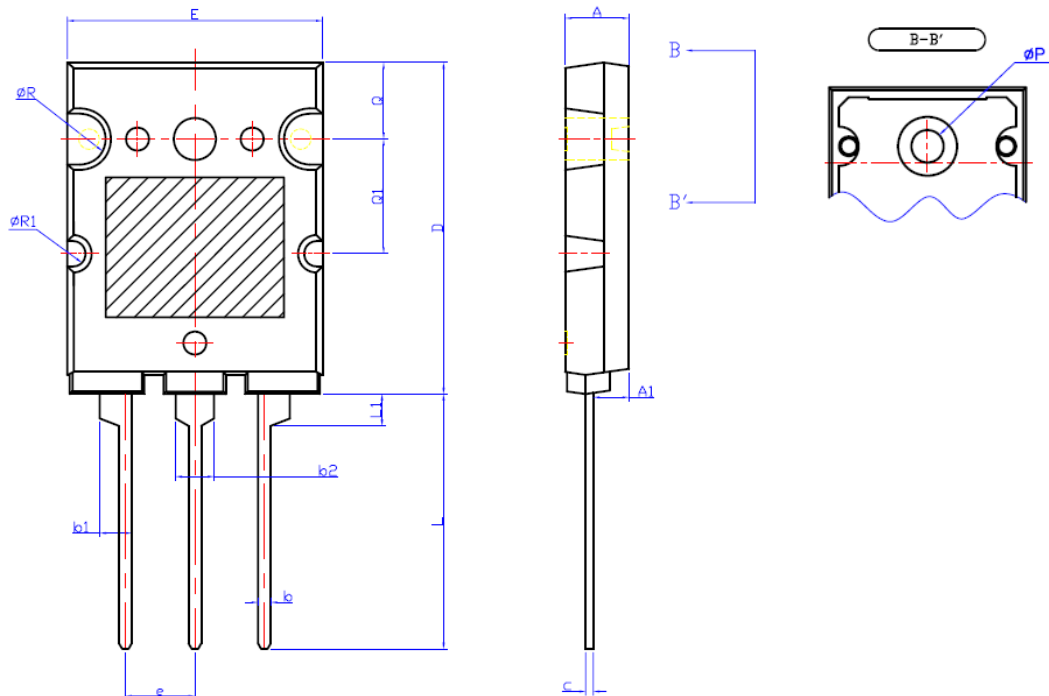


Fig. 21 Reverse recovery time vs. forward current



**TO-264 MECHANICAL DATA**



SYMBOL	MIN	NOM	MAX
A	4.80	5.00	5.20
A1	2.50	2.80	3.10
b	0.90	1.00	1.25
b1	2.30	2.50	2.70
b2	2.80	3.00	3.20
c	0.50	0.60	0.85
D	25.80	26.00	26.20
E	19.80	20.00	20.20
e	5.15	5.45	5.75
L	19.50	20.00	20.50
L1	2.40	2.50	2.60
phi P	3.00	3.20	3.40
Q	5.80	6.00	6.20
Q1	8.80	9.00	9.20
phi R	(2.00)		
phi R1	(1.00)		



## Notes

- **RoHS Compliance**  
The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented March, 2013. RoHS Declarations for this product can be obtained from the Product Documentation sections of [www.gptechgroup.com](http://www.gptechgroup.com).
- **REACH Compliance**  
REACH substances of high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, please contact our office at GPTG Headquarters in Lake Forest, California to insure you get the most up-to-date REACH SVHC Declaration.  
REACH banned substance information (REACH Article 67) is also available upon request.
- This product has not been designed or tested for use in, and is not intended for use in, applications implanted into the human body nor in applications in which failure of the product could lead to death, personal injury or property damage, including but not limited to equipment used in the operation of nuclear facilities, life-support machines, cardiac defibrillators or similar emergency medical equipment, aircraft navigation or communication or control systems, or air traffic control.
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